

Notice for TAIYO YUDEN Products

Please read this notice before using the TAIYO YUDEN products.

? REMINDERS

Product Information in this Catalog

Product information in this catalog is as of March 2023. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN.

TAIYO YUDEN has the product series intended for use in the following equipment. Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

Application	Product Series		Quality Grade*3	
Application	Equipment *1	Category (Part Number Code *2)	Quality Grade 9	
Automotive	Automotive Electronic Equipment (POWERTRAIN, SAFETY)	А	1	
Adtornotive	Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT)	С	2	
Industrial	Telecommunications Infrastructure and Industrial Equipment	В	2	
Medical	Medical Devices classified as GHTF Class C (Japan Class III)	M	2	
iviedicai	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	L	3	
Consumer	General Electronic Equipment	S	3	
Consumer	Only for Mobile Devices *4	E	4	

^{*}Notes:1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAIYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAIYO YUDEN before using our products for equipment other than those covered by the product series.

^{2.} On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details, please check the explanatory materials regarding the part numbering system of each of our products.

^{3.} Each product series is assigned a "Quality Grade" from 1 to 4 in order of higher quality. Please do not incorporate a product into any equipment with a higher Quality Grade than the Quality Grade of such product without the prior written consent of TAIYO YUDEN.

^{4.} The applications covered by this product series are limited to mobile devices (smartphone, tablet PC, smartwatch, handheld game console, etc.) among general electronic equipment for consumer. The design, specifications and operating environment, etc. differ from those of the product series for "General Electronic Equipment" (Category: S), so please check the individual product specification sheets for details. The product series for "General Electronic Equipment" (Category: S) can also be used for mobile devices.

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2
- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above
- *Notes:1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
 - 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets.

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

2023

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Automotive Application Guide

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. Therefore, we have the corresponding product series (the 2nd code from the left side of the part number is "A" or "C"). When using our products for automotive electronic equipment, please be sure to check such application categories and use the corresponding product series accordingly. Should you have any questions on this matter, please contact us.

Product Series (The 2nd Code from the Left Side of the Part Number)	Category	Automotive Electronic Equipment (Typical Example)
А	POWERTRAIN	 Engine ECU (Electronically Controlled Fuel Injector) Cruise Control Unit 4WS (4 Wheel Steering) Transmission Power Steering HEV/PHV/EV Core Control (Battery, Inverter, DC-DC) Automotive Locator (Car location information providing device), etc.
	SAFETY	 ABS (Anti-Lock Brake System) ESC (Electronic Stability Control) Airbag ADAS (Equipment that directly controls running, turning and stopping), etc.
С	BODY & CHASSIS	Wiper Automatic Door Power Window Keyless Entry System Electric Door Mirror Automobile Digital Mirror Interior Lighting Automobile Air Conditioning System TPMS (Tire Pressure Monitoring System) Anti-Theft Device (Immobilizer) ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain), etc.
	INFOTAINMENT	Car Infotainment System ITS/Telematics System Instrument Cluster Panel Dashcam (genuine products for automotive manufacturer), etc.

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Multilayer Ceramic Capacitors for Automotive Body & Chassis and Infotainment

REFLOW AEC-Q200

■PART NUMBER

М	С	Α	S	J	3	1	L	S	В	5	1	0	6	K	Т	N	Α	0	1
	(1)		2		3)	4	(5)	(6	3		7		8	9		(1	0	

1)Series

<u> </u>	
Code (1)(2)(3)(4)	
-	Multilayer Ceramic Capacitor (High dielectric type) for Automotive Body & Chassis and Infotainment
MCAS	Multilayer Ceramic Capacitor (Temperature compensating type) for Automotive Body & Chassis and Infotainment
	Medium-High voltage Multilayer Ceramic Capacitor for Automotive Body & Chassis and Infotainment
MCAR	High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitor for Automotive Body & Chassis and Infotainment
MCJC	Soft Termination Multilayer Ceramic Capacitor for Automotive Body & Chassis and Infotainment
MCRL	LW Reversal Decoupling Low ESL Capacitor (LWDC™) for Automotive Body & Chassis and Infotainment

(1) Product Group

Code	
М	Multilayer Ceramic Capacitor

(2) Category

Code	Recommended equipment	Quality Grade
С	Automotive Electronic Equipment (Body & Chassis, Infotainment)	2

(3) Type

Code	
Α	2 terminals
J	Soft Termination
R	LW reversal

(4) Features, Characteristics

Code	
S	Standard/General
R	High frequency/Low loss
С	Internal code (Soft Termination)
L	Low ESL

2Rated voltage

Entacca voltage	
Code	Rated voltage[VDC]
Α	4
J	6.3
L	10
E	16
Т	25
G	35
U	50
Н	100
Q	250
S	630

$\Im Dimension(L \times W)$

Code	L×W [mm]	JIS(mm)	EIA(inch)
Code	L ~ W [IIIII]	013(11111)	EIA(IIICII)
06	0.6 × 0.3	0603	0201
10	1.0 × 0.5	1005	0402
	0.52 × 1.0 💥	0510	0204
16	1.6 × 0.8	1608	0603
	0.8 × 1.6 💥	0816	0306
21	2.0 × 1.25	2012	0805
	1.25 × 2.0 💥	1220	0508
31	3.2 × 1.6	3216	1206
32	3.2 × 2.5	3225	1210
45	4.5 × 3.2	4532	1812
\1/	/	•	•

Note: XLW reverse type (MCRL)

4 Thickness

Code	Thickness[mm]
3	0.3
5	0.5
7	0.7
8	0.8
9	0.85
Q	1.15
G	1.25
L	1.6
N	1.9 (0.088 max ※)
М	2.5

Note: XLW reverse type (MCRL)

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification.

5Dimension tolerance

Code	Dimension code	L[mm]	W[mm]	T[mm]	Thickness code		
	10	1.0±0.10	0.5±0.10	0.5±0.10	5		
	16	1.6+0.15/-0.05	0.8+0.15/-0.05	0.8+0.15/-0.05	8		
	21	2.0+0.15/-0.05	1.25+0.15/-0.05	1.25+0.15/-0.05	G		
Α	31	3.2±0.20	1.6±0.20	1.15±0.20	Q		
	31	3.2 ± 0.20	1.0 ± 0.20	1.6±0.20	L		
	32	3.2±0.30	2.5±0.30	2.5±0.30	М		
	10	1.0+0.15/-0.05	0.5+0.15/-0.05	0.5+0.15/-0.05	5		
В	16	1.6+0.20/-0	0.8+0.20/-0	0.8+0.20/-0	8		
В	21	2.0+0.20/-0	1.25+0.20/-0	1.25+0.20/-0	G		
	31	3.2±0.30	1.6±0.30	1.6±0.30	L		
	10	1.0+0.20/-0	0.5+0.20/-0	0.5+0.20/-0	5		
С	16	1.6+0.25/-0	0.8+0.25/-0	0.8+0.25/-0	8		
	21	2.0+0.25/-0	1.25+0.25/-0	1.25+0.25/-0	G		
D	21	2.0+0.30/-0	1.25+0.30/-0	1.25+0.30/-0	G		
Н	31	3.2±0.15	1.6±0.15	1.15±0.10	Q		
J	21	2.0+0.15/-0.05	1.25+0.15/-0.05	0.85±0.10	9		
1	21	2.0+0.20/-0	1.25+0.20/-0	0.85±0.10	9		
L	32	3.2±0.50	2.5±0.30	2.5±0.30	М		
N	21	2.0±0.15	1.25±0.15	0.85±0.15	9		
	06	0.6±0.03	0.3±0.03	0.3±0.03	3		
	10	1.0±0.05	0.5±0.05	0.5±0.05	5		
	10	0.52±0.05 ※	1.0±0.05	0.3±0.05	3		
		1.6±0.10	0.8±0.10	0.7±0.10	7		
	16	1.6±0.10	0.8±0.10	0.8±0.10	8		
		0.8±0.10 ※	1.6±0.10	0.5±0.05	5		
S		2.0±0.10	1.25±0.10	0.85±0.10	9		
	21	2.0±0.10	1.25±0.10	1.25±0.10	G		
		1.25±0.15 ※	2.0±0.15	0.85±0.10	9		
	31	3.2±0.15	1.6±0.15	1.6±0.20	L		
	20	2 2 + 0 20	25+020	1.9±0.20	N		
	32	3.2±0.30	2.5±0.20	2.5±0.20	М		
	45	4.5±0.40	3.2±0.30	2.5±0.20	М		

Note: XLW reverse type (MCRL)

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®Temperature characteristics code

■ High dielectric type

Code	Applicable standard		Temperature range[°C]	Ref. Temp.[°C]	Capacitance change	Capacitance tolerance	Tolerance code
B5	EIA	X5R	-55~+ 85	25	±15%	±10%	K
	EIA XOR		_55~ + 65	25	土13%	±20%	М
06	C6 EIA X6S	VEC	-55~+105	25	±22%	±10%	K
		A03	-33.4 + 103	25	± 22%	±20%	М
В7	EIA	X7R	−55~+125	25	±15%	±10%	K
ь/	EIA	λ/Κ			土13%	±20%	М
C7	EIA	X7S	-55~+125	25	±22%	±10%	K
C/	EIA	X/S	-55~+125	25	±22%	±20%	М
D7	EIA	A X7T	FF 140F	25	+22%/-33%	±10%	K
<i>U1</i>	EIA	X/1	−55∼+125	25	+22%/-33%	±20%	М

■Temperature compensating type

Code		cable dard	Temperature range[°C]	Ref. Temp.[°C]	Capacitance change	Capacitance tolerance	Tolerance code
	Stan	luaru	Tange [O]			±0.05pF	A
	JIS	CG		20		±0.1pF	В
CG			FF 10F		0±30ppm/°C	±0.25pF	С
CG			−55 ~ +125	25	U±3Uppm/ C	±0.5pF	D
	EIA	C0G				±2%	G
						±5%	J
	JIS	JIS CH		20		±0.25pF	С
CH	013	OH	$-55 \sim +125$	20	0±60ppm/°C	±0.5pF	D
	EIA	C0H		25		±5%	J
CJ	JIS	CJ	-55 ~ +125	20	0±120ppm/°C	±0.25pF	С
Co	EIA	C0J	-33.4 + 123	25	0±120ppiii/ C	±0.23pr	C
СК	JIS	CK	-55 ~ +125	20	0±250ppm/°C	±0.25pF	С
CK	EIA	C0K	00 1120	25	о ± 200ррпп/ О	± 0.23β1	9

7Nominal capacitance

Code (example)	Nominal capacitance
0R5	0.5pF
010	1pF
100	10pF
101	100pF
102	1,000pF
103	0.01μF
104	0.1μF
105	1μF
106	10μF
107	100μF

Note : R=Decimal point

8 Capacitance tolerance

© Capacitance tolerance							
Code	Capacitance tolerance						
Α	±0.05pF						
В	±0.1pF						
С	±0.25pF						
D	±0.5pF						
G	±2%						
J	±5%						
K	±10%						
М	±20%						

Code	Packaging
F	ϕ 178mm Taping (2mm pitch)
R	φ178mm Embossed Taping (4mm pitch)
Т	ϕ 178mm Taping (4mm pitch)
Р	ϕ 178mm Taping (4mm pitch, 1000 pcs/reel) 3225 type(Thickness code M)

1Internal code

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М

 0.9 ± 0.6

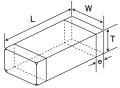
 (0.035 ± 0.024)

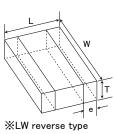
 (0.098 ± 0.008)

 2.5 ± 0.20

 (0.098 ± 0.008)

■STANDARD EXTERNAL DIMENSIONS





T	JIS	EIA	Dimension [mm] (inch)						
Туре	(mm)	(inch)	L	W	Т	*1	е		
MCAS□06	0603	0201	0.6±0.03 (0.024±0.001)	0.3±0.03 (0.012±0.001)	0.3±0.03 (0.012±0.001)	3	0.15±0.05 (0.006±0.002)		
MCAR□10 MCAS□10	1005	0402	1.0±0.05 (0.039±0.002)	0.5±0.05 (0.020±0.002)	0.5±0.05 (0.020±0.002)	5	0.25±0.10 (0.010±0.004)		
MCRL□10 ※	0510	0204	0.52±0.05 (0.020±0.002)	1.0±0.05 (0.039±0.002)	0.3±0.05 (0.012±0.002)	3	0.18±0.08 (0.007±0.003)		
MCAS□16 MCAR□16	1608	0603	1.6±0.10 (0.063±0.004)	0.8±0.10 (0.031±0.004)	0.7±0.10 (0.028±0.004) 0.8±0.10	7	0.35±0.25 (0.014±0.010)		
WICARLI 10					(0.031 ± 0.004)	8			
MCJC□16	1608	0603	1.6±0.10 (0.063±0.004)	0.8±0.10 (0.031±0.004)	0.8 ± 0.10 (0.031 \pm 0.004)	8	0.35 + 0.3 / -0.25 (0.014+0.012/-0.010)		
MCRL□16 ※	0816	0306	0.8±0.10 (0.031±0.004)	1.6±0.10 (0.063±0.004)	0.5±0.05 (0.020±0.002)	5	0.25±0.15 (0.010±0.006)		
MCAS□21	0010	0805	2.0±0.10	1.25±0.10	0.85±0.10 (0.033±0.004)	9	0.5±0.25		
MCAR□21	MCAR□21 2012	0803	(0.079 ± 0.004)	(0.049 ± 0.004)	1.25±0.10 (0.049±0.004)	G	(0.020±0.010)		
		2012 0805	2.0±0.10	1.25±0.10	0.85±0.10 (0.033±0.004)	9	0.5+0.35/-0.25		
MCJC□21	2012		(0.079 ± 0.004)	(0.049 ± 0.004)	1.25±0.10 (0.049±0.004)	G	(0.020 + 0.014 / -0.010)		
MCRL□21 ※	1220	0508	1.25±0.15 (0.049±0.006)	2.0±0.15 (0.079±0.006)	0.85±0.10 (0.033±0.004)	9	0.3±0.2 (0.012±0.008)		
			3.2±0.15	1.6±0.15	1.15±0.10 (0.045±0.004)	Q	0.5+0.35/-0.25		
MCAS□31	3216	1206	(0.126±0.006)	(0.063±0.006)	1.6±0.20 (0.063±0.008)	L	(0.020+0.014/-0.010)		
			3.2±0.15	1.6±0.15	1.15±0.10 (0.045±0.004)	Q	0.6+0.4/-0.3		
MCJC□31	3216	1206	(0.126±0.006)	(0.063±0.006)	1.6±0.20 (0.063±0.008)	L	(0.024 + 0.016 / -0.012)		
			3.2±0.30	2.5±0.20	1.9±0.20 (0.075±0.008)	N	0.6±0.3		
MCAS□32	3225	1210	(0.126±0.012)	(0.098±0.008)	2.5±0.20 (0.098±0.008)	М	(0.024±0.012)		
MCJC□32	3225	1210	3.2±0.30 (0.126±0.012)	2.5±0.20 (0.098±0.008)	1.9±0.20 (0.075±0.008) 2.5±0.20	N	0.6+0.4/-0.3 (0.024+0.016/-0.012)		
			(3.120 = 0.012)	(5.000 ± 0.000)	(0.000 + 0.000)	М	$(0.024 \pm 0.016 / -0.012)$		

 3.2 ± 0.30

 (0.126 ± 0.012)

Note: **LW reverse type(MCRL), *1.Thickness code

1812

4532

MCAS□45

 4.5 ± 0.40

 (0.177 ± 0.016)

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■STANDARD QUANTITY

	Туре		Thick	ness	Standard quantity[pcs]		
Code	JIS(mm)	EIA(inch)	[mm]	Code	Paper tape	Embossed tape	
06	0603	0201	0.3	3	15000	_	
10	1005	0402	0.5	5	10000	_	
10	0510 💥	0204 💥	0.3	3	10000	_	
			0.7	7	4000		
	1608	0603	0.8	8	4000	_	
16	1608	0603	0.0	0	3000	3000	
			0.8	8	(Soft Termination)	(Soft Termination)	
	0816 💥	0306 ※	0.5	5	_	4000	
		0805	0.85	9	4000	_	
	2012		1.25	G	_	3000	
21	2012	0805	1.25	G	_	2000	
			1.20	G	_	(Soft Termination)	
	1220 💥	0508 💥	0.85	9	4000	-	
31	3216	1206	1.15	Q	_	3000	
31	3210	1200	1.6	L	_	2000	
20	2005	1010	1.9	N	_	2000	
32	3225	1210	2.5	M	_	500(T), 1000(P)	
45	4532	1812	2.5	M	_	500	

Note: X.LW Reverse type(MCRL)

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High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitors for Automotive Body & Chassis and Infotainment

1005TYPF

[Temperature Characteristic CG : CG/C0G($-55 \sim +125$ °C)] 0.5mm Thickness

Licinporatare enaracte	ristic CG : CG/C0G(00 112	.0 0/1	0.0111111	THICKIICSS					
Name and according	Old part number	Rated voltage	Tempe	erature	Capacitance	0:	Q	HTLT	*1 - 3	NI-4-
New part number	(for reference)	[V]	charact	eristics	[F]	Capacitance tolerance	[at 1MHz] (Min)	Rated voltage x %	Thickness*1 [mm]	Note
MCARQ105SCG0R5[FRA01	QVS105 CG0R5[]VHF		CG	COG	0.5 p	±0.1pF, ±0.25pF	810	200	0.5±0.05	
	QVS105 CG0R6 VHF	•	CG	COG	0.5 p	±0.1pF, ±0.25pF	812	200	0.5±0.05	
	QVS105 CG0R7 VHF	•	CG	COG	0.0 p	±0.1pF, ±0.25pF	814	200	0.5±0.05	
	QVS105 CGR75 VHF	•	CG	COG	0.7 p	±0.1pF, ±0.25pF	815	200	0.5±0.05	
	QVS105 CG0R8 VHF	•	CG	COG	0.73 p	±0.1pF, ±0.25pF	816	200	0.5±0.05	
	QVS105 CG0R9[]VHF	•	CG	COG	0.8 p	±0.1pF, ±0.25pF	818	200	0.5±0.05	
	QVS105 CG010 VHF	•	CG	COG	0.5 p	±0.1pF, ±0.25pF	820	200	0.5±0.05	
	QVS105 CG1R1 VHF	•	CG	COG	1.1 p	±0.1pF, ±0.25pF	822	200	0.5±0.05	
	QVS105 CG1R2[]VHF	•	CG	COG	1.1 p	±0.1pF, ±0.25pF	824	200	0.5±0.05	
	QVS105 CG1R3[]VHF	•	CG	COG	1.2 p	±0.1pF, ±0.25pF	826	200	0.5±0.05	
			CG	COG			830	200	0.5±0.05	
	QVS105 CG1R5 VHF QVS105 CG1R6 VHF	 	CG	COG	1.5 p 1.6 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	830	200	0.5±0.05 0.5±0.05	
	QVS105 CG1R6[]VHF	 	CG	COG	1.6 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	832	200	0.5±0.05 0.5±0.05	
	QVS105 CG1R8[]VHF	 	CG	COG	1.8 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	840	200	0.5±0.05 0.5±0.05	
	QVS105 CG020[]VHF		CG	COG		±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	844	200	0.5±0.05	
			CG	COG	2.2 p			200		
	QVS105 CG2R4[]VHF				2.4 p	±0.1pF, ±0.25pF	848		0.5±0.05	
	QVS105 CG2R7[]VHF		CG	COG	2.7 p	±0.1pF, ±0.25pF	854	200	0.5±0.05	
	QVS105 CG030[]VHF		CG	COG	3 p	±0.1pF, ±0.25pF	860	200	0.5±0.05	
	QVS105 CG3R3 VHF		CG	C0G	3.3 p	±0.1pF, ±0.25pF	866	200	0.5±0.05	
	QVS105 CG3R6 VHF		CG	COG	3.6 p	±0.1pF, ±0.25pF	872	200	0.5±0.05	
	QVS105 CG3R9[]VHF		CG	COG	3.9 p	±0.1pF, ±0.25pF	878	200	0.5±0.05	
	QVS105 CG4R3[]VHF	250	CG	C0G	4.3 p	±0.1pF, ±0.25pF	886	200	0.5±0.05	
	QVS105 CG4R7[]VHF		CG	C0G	4.7 p	±0.1pF, ±0.25pF	894	200	0.5±0.05	
	QVS105 CG5R1[]VHF		CG	COG	5.1 p	$\pm 0.25 pF, \pm 0.5 pF$	902	200	0.5±0.05	
	QVS105 CG5R6[]VHF		CG	C0G	5.6 p	±0.25pF, ±0.5pF	912	200	0.5 ± 0.05	
	QVS105 CG6R2[]VHF		CG	C0G	6.2 p	$\pm 0.25 pF, \pm 0.5 pF$	924	200	0.5±0.05	
	QVS105 CG6R8[]VHF		CG	C0G	6.8 p	$\pm 0.25 pF, \pm 0.5 pF$	936	200	0.5 ± 0.05	
	QVS105 CG7R5[]VHF		CG	C0G	7.5 p	$\pm 0.25 pF, \pm 0.5 pF$	950	200	0.5 ± 0.05	
	QVS105 CG8R2[]VHF		CG	C0G	8.2 p	$\pm 0.25 pF, \pm 0.5 pF$	964	200	0.5 ± 0.05	
	QVS105 CG9R1[]VHF		CG	C0G	9.1 p	$\pm 0.25 pF, \pm 0.5 pF$	982	200	0.5 ± 0.05	
	QVS105 CG100JVHF		CG	C0G	10 p	±5%	1000	200	0.5 ± 0.05	
	QVS105 CG110JVHF		CG	C0G	11 p	±5%	1020	200	0.5 ± 0.05	
MCARQ105SCG120JFRA01	QVS105 CG120JVHF		CG	C0G	12 p	±5%	1040	200	0.5 ± 0.05	
MCARQ105SCG130JFRA01	QVS105 CG130JVHF		CG	C0G	13 p	±5%	1060	200	0.5 ± 0.05	
MCARQ105SCG150JFRA01	QVS105 CG150JVHF		CG	C0G	15 p	±5%	1100	200	0.5 ± 0.05	
MCARQ105SCG160JFRA01	QVS105 CG160JVHF		CG	COG	16 p	±5%	1120	200	0.5 ± 0.05	
MCARQ105SCG180JFRA01	QVS105 CG180JVHF		CG	COG	18 p	±5%	1160	200	0.5 ± 0.05	
MCARQ105SCG200JFRA01	QVS105 CG200JVHF		CG	COG	20 p	±5%	1200	200	0.5 ± 0.05	
MCARQ105SCG220JFRA01	QVS105 CG220JVHF		CG	C0G	22 p	±5%	1240	200	0.5±0.05	
MCARQ105SCG240JFRA01	QVS105 CG240JVHF]	CG	COG	24 p	±5%	1280	200	0.5 ± 0.05	
MCARQ105SCG270JFRA01	QVS105 CG270JVHF	1	CG	COG	27 p	±5%	1340	200	0.5±0.05	
	QVS105 CG300JVHF	1	CG	COG	30 p	±5%	1400	200	0.5±0.05	
MCARQ105SCG330JFRA01	QVS105 CG330JVHF	1	CG	COG	33 p	±5%	1400	200	0.5±0.05	

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

PART NUMBER

●1608TYPE

[Temperature Characteristic CG : CG/C0G(-55~+125°C)] 0.7mm Thickness

Temperature Orial act	Old part number	Rated voltage		erature	Capacitance		Q	HTLT	1	
New part number	(for reference)	[V]		eristics	[F]	Capacitance tolerance	[at 1MHz] (Min)	Rated voltage x %	Thickness*1 [mm]	Note
MCARQ167SCG0R2[]TRA01	QVS107 CG0R2[CHT		CG	COG	0.2 p	±0.05pF, ±0.1pF	804	200	0.7±0.10	
MCARQ167SCG0R3[]TRA01	QVS107 CG0R3[CHT		CG	COG	0.3 p	±0.05pF, ±0.1pF	806	200	0.7±0.10	
MCARQ167SCG0R4[]TRA01	QVS107 CG0R4[]CHT	1	CG	COG	0.4 p	±0.05pF, ±0.1pF	808	200	0.7±0.10	
MCARQ167SCG0R5[]TRA01	QVS107 CG0R5[]CHT		CG	COG	0.5 p	±0.1pF, ±0.25pF	810	200	0.7±0.10	
MCARQ167SCG0R6[]TRA01	QVS107 CG0R6∏CHT		CG	COG	0.6 p	±0.1pF, ±0.25pF	812	200	0.7±0.10	
MCARQ167SCG0R7[]TRA01	QVS107 CG0R7[]CHT		CG	COG	0.7 p	±0.1pF, ±0.25pF	814	200	0.7±0.10	
MCARQ167SCGR75[]TRA01	QVS107 CGR75[]CHT		CG	COG	0.75 p	±0.1pF, ±0.25pF	815	200	0.7±0.10	
MCARQ167SCG0R8[]TRA01	QVS107 CG0R8[]CHT	1	CG	COG	0.8 p	±0.1pF, ±0.25pF	816	200	0.7±0.10	
MCARQ167SCG0R9[]TRA01	QVS107 CG0R9[]CHT	1	CG	COG	0.9 p	±0.1pF, ±0.25pF	818	200	0.7±0.10	
MCARQ167SCG010[]TRA01	QVS107 CG010 CHT] [CG	COG	1 p	±0.1pF, ±0.25pF	820	200	0.7±0.10	
MCARQ167SCG1R1[]TRA01	QVS107 CG1R1[CHT] [CG	COG	1.1 p	$\pm 0.1 pF, \pm 0.25 pF$	822	200	0.7±0.10	
MCARQ167SCG1R2[]TRA01	QVS107 CG1R2[]CHT	1	CG	COG	1.2 p	±0.1pF, ±0.25pF	824	200	0.7±0.10	
MCARQ167SCG1R3[]TRA01	QVS107 CG1R3[]CHT	1	CG	COG	1.3 p	±0.1pF, ±0.25pF	826	200	0.7±0.10	
MCARQ167SCG1R5[]TRA01	QVS107 CG1R5[CHT		CG	COG	1.5 p	±0.1pF, ±0.25pF	830	200	0.7±0.10	
MCARQ167SCG1R6[]TRA01	QVS107 CG1R6 CHT] [CG	COG	1.6 p	±0.1pF, ±0.25pF	832	200	0.7±0.10	
MCARQ167SCG1R8[]TRA01	QVS107 CG1R8 CHT] [CG	COG	1.8 p	±0.1pF, ±0.25pF	836	200	0.7±0.10	
MCARQ167SCG020 TRA01	QVS107 CG020 CHT]	CG	COG	2 p	±0.1pF, ±0.25pF	840	200	0.7±0.10	
MCARQ167SCG2R2[]TRA01	QVS107 CG2R2[]CHT]	CG	COG	2.2 p	±0.1pF, ±0.25pF	844	200	0.7±0.10	
MCARQ167SCG2R4[]TRA01	QVS107 CG2R4[]CHT		CG	COG	2.4 p	±0.1pF, ±0.25pF	848	200	0.7±0.10	
MCARQ167SCG2R7[]TRA01	QVS107 CG2R7[]CHT] [CG	COG	2.7 p	±0.1pF, ±0.25pF	854	200	0.7±0.10	
MCARQ167SCG030[]TRA01	QVS107 CG030∏CHT	1	CG	COG	3 p	±0.1pF, ±0.25pF	860	200	0.7±0.10	
MCARQ167SCG3R3[]TRA01	QVS107 CG3R3[]CHT	1	CG	COG	3.3 p	±0.1pF, ±0.25pF	866	200	0.7±0.10	
MCARQ167SCG3R6[]TRA01	QVS107 CG3R6∏CHT	1	CG	COG	3.6 p	±0.1pF, ±0.25pF	872	200	0.7±0.10	
MCARQ167SCG3R9[]TRA01	QVS107 CG3R9∏CHT	1	CG	COG	3.9 p	±0.1pF, ±0.25pF	878	200	0.7±0.10	
MCARQ167SCG4R3[]TRA01	QVS107 CG4R3 CHT	1	CG	COG	4.3 p	±0.1pF, ±0.25pF	886	200	0.7±0.10	
MCARQ167SCG4R7[]TRA01	QVS107 CG4R7[]CHT		CG	COG	4.7 p	±0.1pF, ±0.25pF	894	200	0.7±0.10	
MCARQ167SCG5R1[]TRA01	QVS107 CG5R1 CHT		CG	COG	5.1 p	±0.25pF, ±0.5pF	902	200	0.7±0.10	
MCARQ167SCG5R6[]TRA01	QVS107 CG5R6[]CHT	1	CG	COG	5.6 p	±0.25pF, ±0.5pF	912	200	0.7±0.10	
MCARQ167SCG6R2[]TRA01	QVS107 CG6R2[CHT	250	CG	COG	6.2 p	±0.25pF, ±0.5pF	924	200	0.7±0.10	
MCARQ167SCG6R8[]TRA01	QVS107 CG6R8∏CHT	250	CG	COG	6.8 p	±0.25pF, ±0.5pF	936	200	0.7±0.10	
MCARQ167SCG7R5[]TRA01	QVS107 CG7R5[]CHT		CG	COG	7.5 p	±0.25pF, ±0.5pF	950	200	0.7±0.10	
MCARQ167SCG8R2[]TRA01	QVS107 CG8R2[]CHT	1	CG	COG	8.2 p	±0.25pF, ±0.5pF	964	200	0.7±0.10	
MCARQ167SCG9R1[]TRA01	QVS107 CG9R1 CHT	1	CG	COG	9.1 p	±0.25pF, ±0.5pF	982	200	0.7±0.10	
MCARQ167SCG100[]TRA01	QVS107 CG100 CHT	1	CG	COG	10 p	±2%, ±5%	1000	200	0.7±0.10	
MCARQ167SCG110JTRA01	QVS107 CG110JCHT		CG	COG	11 p	±5%	1020	200	0.7±0.10	
MCARQ167SCG120JTRA01	QVS107 CG120JCHT		CG	COG	12 p	±5%	1040	200	0.7±0.10	
MCARQ167SCG130JTRA01	QVS107 CG130JCHT	1	CG	COG	13 p	±5%	1060	200	0.7±0.10	
MCARQ167SCG150JTRA01	QVS107 CG150JCHT		CG	COG	15 p	±5%	1100	200	0.7±0.10	
MCARQ167SCG160JTRA01	QVS107 CG160JCHT	1	CG	COG	16 p	±5%	1120	200	0.7±0.10	
MCARQ167SCG180JTRA01	QVS107 CG180JCHT		CG	COG	18 p	±5%	1160	200	0.7±0.10	
MCARQ167SCG200JTRA01	QVS107 CG200JCHT		CG	COG	20 p	±5%	1200	200	0.7 ± 0.10	
MCARQ167SCG220JTRA01	QVS107 CG220JCHT		CG	COG	22 p	±5%	1240	200	0.7 ± 0.10	
MCARQ167SCG240JTRA01	QVS107 CG240JCHT] [CG	COG	24 p	±5%	1280	200	0.7±0.10	
MCARQ167SCG270JTRA01	QVS107 CG270JCHT	<u> </u>	CG	COG	27 p	±5%	1340	200	0.7±0.10	
MCARQ167SCG300JTRA01	QVS107 CG300JCHT] [CG	COG	30 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG330JTRA01	QVS107 CG330JCHT	<u> </u>	CG	COG	33 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG360JTRA01	QVS107 CG360JCHT	<u> </u>	CG	COG	36 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG390JTRA01	QVS107 CG390JCHT	<u> </u>	CG	COG	39 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG430JTRA01	QVS107 CG430JCHT] [CG	COG	43 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG470JTRA01	QVS107 CG470JCHT	<u> </u>	CG	COG	47 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG510JTRA01	QVS107 CG510JCHT] [CG	COG	51 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG560JTRA01	QVS107 CG560JCHT] [CG	COG	56 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG620JTRA01	QVS107 CG620JCHT] [CG	COG	62 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG680JTRA01	QVS107 CG680JCHT	<u> </u>	CG	COG	68 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG750JTRA01	QVS107 CG750JCHT	<u> </u>	CG	COG	75 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG820JTRA01	QVS107 CG820JCHT	<u> </u>	CG	COG	82 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG910JTRA01	QVS107 CG910JCHT	<u> </u>	CG	COG	91 p	±5%	1400	200	0.7±0.10	
MCARQ167SCG101JTRA01	QVS107 CG101JCHT		CG	COG	100 p	±5%	1400	200	0.7±0.10	
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PART NUMBER

2012TYPE

[Temperature Characteristic CG : CG/C0G($-55\sim+125^{\circ}$ C)] 0.85mm Thickness

Temperature Gharacte	Old part number	Rated voltage	Tempe		Capacitance		Q	HTLT	w1	
New part number	(for reference)	[V]		eristics	[F]	Capacitance tolerance	[at 1MHz] (Min)	Rated voltage x %	Thickness*1 [mm]	Note
MCARQ219SCG0R3[]TRA01	QVS212 CG0R3[]DHT		CG	C0G	0.3 p	±0.05pF, ±0.1pF, ±0.25pF	806	200	0.85±0.10	
	QVS212 CG0R4[]DHT] [CG	COG	0.4 p	± 0.05 pF, ± 0.1 pF, ± 0.25 pF	808	200	0.85±0.10	
	QVS212 CG0R5[]DHT]	CG	C0G	0.5 p	$\pm 0.1 pF$, $\pm 0.25 pF$	810	200	0.85 ± 0.10	
	QVS212 CG0R6[DHT]	CG	C0G	0.6 p	$\pm 0.1 pF$, $\pm 0.25 pF$	812	200	0.85±0.10	
	QVS212 CG0R7[]DHT]	CG	C0G	0.7 p	$\pm 0.1 pF$, $\pm 0.25 pF$	814	200	0.85 ± 0.10	
	QVS212 CGR75[]DHT]	CG	C0G	0.75 p	±0.1pF, ±0.25pF	815	200	0.85 ± 0.10	
	QVS212 CG0R8[]DHT]	CG	C0G	0.8 p	±0.1pF, ±0.25pF	816	200	0.85 ± 0.10	
	QVS212 CG0R9 DHT		CG	COG	0.9 p	±0.1pF, ±0.25pF	818	200	0.85 ± 0.10	
	QVS212 CG010 DHT		CG	COG	1 p	±0.1pF, ±0.25pF	820	200	0.85±0.10	
	QVS212 CG1R1 DHT		CG	COG	1.1 p	±0.1pF, ±0.25pF	822	200	0.85±0.10	
	QVS212 CG1R2 DHT	4	CG	COG	1.2 p	±0.1pF, ±0.25pF	824	200	0.85±0.10	
	QVS212 CG1R3 DHT	4	CG	COG	1.3 p	±0.1pF, ±0.25pF	826 830	200	0.85±0.10	
	QVS212 CG1R5 DHT	-	CG	COG	1.5 p	±0.1pF, ±0.25pF		200	0.85±0.10	
	QVS212 CG1R6 DHT	-	CG	C0G C0G	1.6 p	±0.1pF, ±0.25pF	832	200 200	0.85±0.10	
	QVS212 CG1R8[]DHT QVS212 CG020[]DHT	-	CG	COG	1.8 p	±0.1pF, ±0.25pF	836 840	200	0.85±0.10 0.85±0.10	
	QVS212 CG020[]DHT	-	CG	COG	2 p 2.2 p	±0.1pF, ±0.25pF	844	200	0.85±0.10	
	QVS212 CG2R2[]DHT	 	CG	COG	2.2 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	848	200	0.85±0.10	
	QVS212 CG2R4DDHT	 	CG	COG	2.4 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	854	200	0.85±0.10	
	QVS212 CG2R/DHT	1	CG	COG	3 p	±0.1pF, ±0.25pF	860	200	0.85±0.10	
	QVS212 CG3R3 DHT	1	CG	COG	3.3 p	±0.1pF, ±0.25pF	866	200	0.85±0.10	
	QVS212 CG3R6 DHT	1	CG	COG	3.6 p	±0.1pF, ±0.25pF	872	200	0.85±0.10	
	QVS212 CG3R9 DHT	1	CG	COG	3.9 p	±0.1pF, ±0.25pF	878	200	0.85±0.10	
	QVS212 CG4R3 DHT	1	CG	COG	4.3 p	±0.1pF, ±0.25pF	886	200	0.85±0.10	
	QVS212 CG4R7 DHT	1	CG	COG	4.7 p	±0.1pF, ±0.25pF	894	200	0.85±0.10	
	QVS212 CG5R1 DHT	1	CG	COG	5.1 p	±0.25pF, ±0.5pF	902	200	0.85±0.10	
	QVS212 CG5R6 DHT	1	CG	COG	5.6 p	±0.25pF, ±0.5pF	912	200	0.85±0.10	
	QVS212 CG6R2[]DHT	1	CG	COG	6.2 p	±0.25pF, ±0.5pF	924	200	0.85±0.10	
	QVS212 CG6R8 DHT	250	CG	COG	6.8 p	±0.25pF, ±0.5pF	936	200	0.85±0.10	
	QVS212 CG7R5[]DHT	1	CG	COG	7.5 p	±0.25pF, ±0.5pF	950	200	0.85±0.10	
	QVS212 CG8R2[]DHT	1	CG	COG	8.2 p	±0.25pF, ±0.5pF	964	200	0.85±0.10	
MCARQ219SCG9R1[]TRA01	QVS212 CG9R1 DHT	1	CG	COG	9.1 p	±0.25pF, ±0.5pF	982	200	0.85±0.10	
MCARQ219SCG100JTRA01	QVS212 CG100JDHT	1	CG	COG	10 p	±5%	1000	200	0.85±0.10	
MCARQ219SCG110JTRA01	QVS212 CG110JDHT	1	CG	COG	11 p	±5%	1020	200	0.85±0.10	
MCARQ219SCG120JTRA01	QVS212 CG120JDHT] [CG	COG	12 p	±5%	1040	200	0.85±0.10	
MCARQ219SCG130JTRA01	QVS212 CG130JDHT	1	CG	COG	13 p	±5%	1060	200	0.85±0.10	
MCARQ219SCG150JTRA01	QVS212 CG150JDHT] [CG	COG	15 p	±5%	1100	200	0.85±0.10	
MCARQ219SCG160JTRA01	QVS212 CG160JDHT		CG	COG	16 p	±5%	1120	200	0.85 ± 0.10	
MCARQ219SCG180JTRA01	QVS212 CG180JDHT		CG	COG	18 p	±5%	1160	200	0.85 ± 0.10	
MCARQ219SCG200JTRA01	QVS212 CG200JDHT		CG	COG	20 p	±5%	1200	200	0.85 ± 0.10	
MCARQ219SCG220JTRA01	QVS212 CG220JDHT]	CG	COG	22 p	±5%	1240	200	0.85±0.10	
	QVS212 CG240JDHT	<u>,</u> [CG	C0G	24 p	±5%	1280	200	0.85±0.10	
	QVS212 CG270JDHT]	CG	C0G	27 p	±5%	1340	200	0.85 ± 0.10	
	QVS212 CG300JDHT	<u>.</u>	CG	C0G	30 p	±5%	1400	200	0.85 ± 0.10	
-	QVS212 CG330JDHT	<u>,</u> [CG	COG	33 p	±5%	1400	200	0.85±0.10	
	QVS212 CG360JDHT]	CG	C0G	36 p	±5%	1400	200	0.85 ± 0.10	
	QVS212 CG390JDHT]	CG	C0G	39 p	±5%	1400	200	0.85 ± 0.10	
	QVS212 CG430JDHT]	CG	COG	43 p	±5%	1400	200	0.85 ± 0.10	
	QVS212 CG470JDHT	<u> </u>	CG	COG	47 p	±5%	1400	200	0.85±0.10	
	QVS212 CG510JDHT	<u> </u>	CG	COG	51 p	±5%	1400	200	0.85±0.10	
	QVS212 CG560JDHT		CG	COG	56 p	±5%	1400	200	0.85±0.10	
	QVS212 CG620JDHT	<u> </u>	CG	COG	62 p	±5%	1400	200	0.85±0.10	
	QVS212 CG680JDHT		CG	COG	68 p	±5%	1400	200	0.85±0.10	
-	QVS212 CG750JDHT	. I	CG	COG	75 p	±5%	1400	200	0.85±0.10	
	QVS212 CG820JDHT	4 l	CG	COG	82 p	±5%	1400	200	0.85±0.10	
	QVS212 CG910JDHT QVS212 CG101JDHT	4 l	CG	COG	91 p	±5%	1400 1400	200	0.85±0.10	
			(i(i	COG	100 p	±5%	1400	200	0.85 ± 0.10	

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Multilayer Ceramic Capacitors

PACKAGING

①Minimum Quantity

Taped package

Туре		Thick	ness	Standard Q	Standard Quantity[pcs]				
Code	JIS(mm)	EIA(inch)	[mm]	Code	Paper tape	Embossed tape			
02	0201	008004	0.125	1	_	50000			
04	0402	01005	0.2	2	_	40000			
06	0603	0201	0.3	3	15000	_			
			0.13	Н	_	20000			
41	1005	0.400	0.18	Е	_	15000			
1L	1005	0402	0.2	2	20000	_			
			0.3	3	15000	_			
40	1005	0402	0.5	5	10000	_			
10	0510 💥	0204	0.3	3	10000	_			
	16 1608		0.45	K					
			0.7	7	4000	_			
16		0603	0.8	8					
10			0.8	8	3000	3000			
			0.8	8	(Soft Termination)	(Soft Termination			
	0816 💥	0306	0.5	5	_	4000			
		0805	0905	0805	0905	0.85	9	4000	_
	2012					0005	0005	1.25	G
21	2012		1.25	G	_	2000 (Soft Termination			
	1220 💥	0508	0.85	9	4000	_			
			0.85	9	4000	_			
31	3216	1206	1.15	Q	_	3000			
			1.6	L	_	2000			
			0.85	9					
			1.15	Q		2000			
32	32 3225	1210	1.9	N	_	2000			
	[2.0 max							
			2.5	М	_	500(T), 1000(P)			
45	4532	1812	2.0 max	Υ	_	1000			
40	4002	1012	2.5	М	_	500			

注:※LW Reverse type(MSRL, MCRL, MBRL, MLRL, MMRL)

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②Taping material

**No bottom tape for pressed carrier tape

Card board carrier tape

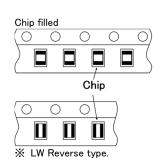
Top tape

Top tape

Base tape

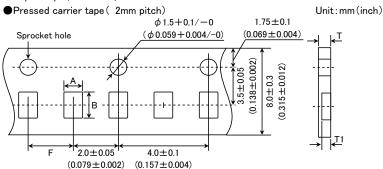
Sprocket hole

Chip cavity



3 Representative taping dimensions

Paper Tape (8mm wide)



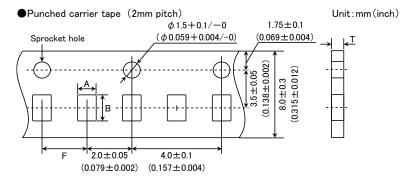
Bottom tape

Type(EIA)	Chip	Cavity	Insertion Pitch	Tape Thickness			
Type(EIA)	Α	В	F	Т	T1		
0603 (0201)	0.37	0.67		0.45	0.40		
0510 (0204) ※		00.005		0.45max.	0.42max.		
1005 (0402) (*1 2)	0.65	1.15	2.0±0.05	0.4max.	0.3max.		
1005 (0402) (*1 3)				0.45max.	0.42max.		
	0 00 01				11.16		

Note *1 Thickness, 2:0.2mm , 3:0.3mm. $\mbox{\%}$ LW Reverse type.

Unit: mm

Base tape



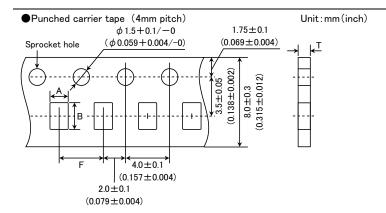
Type(EIA)	Chip	Cavity	Insertion Pitch	Tape Thickness	
Type(EIA	٦)	АВ		F	Т
1005 (0402)		0.65	1.15	2.0±0.05	0.8max.
					Unit:mm

Unit:mm

Sprocket hole

Chip cavity

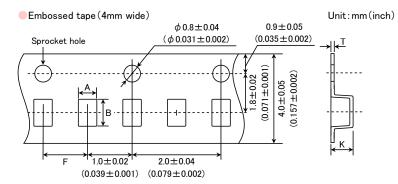
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Type(EIA)	Chip (Cavity	Insertion Pitch	Tape Thickness
Type(EIA)	Α	В	F	Т
1608 (0603) 0816 (0306) ※	1.0	1.8		1.1max.
2012 (0805) 1220 (0508) ※	1.65	2.4	4.0±0.1	1.1max.
3216 (1206)	2.0	3.6		

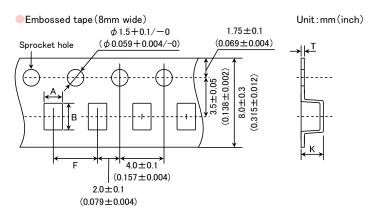
Note: Taping size might be different depending on the size of the product. X LW Reverse type.

Unit:mm



Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
	Α	В	F	K	Т
0201 (008004)	0.135	0.27	1.0±0.02	0.5max.	0.25max.
0402 (01005)	0.23	0.43	1.0±0.02	u.amax.	

Unit:mm



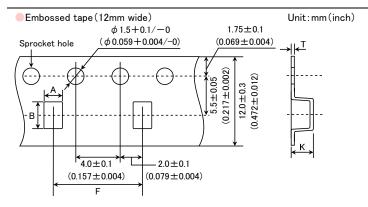
T /FIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
Type(EIA)	Α	В	F	K	Т
1005 (0402)	0.6	1.1	2.0±0.1	0.6max	0.2±0.1
0816 (0306) 💥	1.0	1.8		1.3max.	0.25 ± 0.1
2012 (0805)	1.65	2.4	4.0±0.1	3.4max.	0.6max.
3216 (1206)	2.0	3.6	4.0±0.1		
3225 (1210)	2.8	3.6			

Note:

* LW Reverse type.

Unit:mm

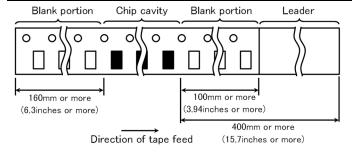
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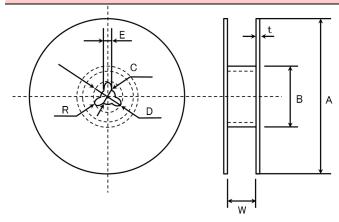
Type(EIA)	Chip (Cavity	Insertion Pitch	Tape Thickness	
	Α	В	F	K	Т
3225 (1210)	3.1	4.0	8.0±0.1	4.0max.	0.6max.
4532 (1812)	3.7	4.9	8.0±0.1	4.0max.	0.6max.

Unit:mm

4Trailer and Leader



5Reel size



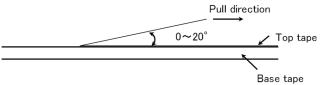
Α	В	С	D	E	R
ϕ 178 ± 2.0	<i>ф</i> 50min.	ϕ 13.0 \pm 0.2	ϕ 21.0 ± 0.8	2.0±0.5	1.0

	Т	W
4mm wide tape	1.5max.	5±1.0
8mm wide tape	2.5max.	10±1.5
12mm wide tape	2.5max.	14±1.5

Unit:mm

6Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



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Multilayer Ceramic Capacitors for Automotive Body & Chassis and Infotainment

■RELIABILITY DATA

1.Operating Temp	perature Range					
	Temperature Compensating(Class1)	−55 to +	−55 to +125°C			
			Specification	Temperature Range		
		B5	X5R	−55 to +85°C		
Specified Value	History (Olssen)	B7	X7R	−55 to +125°C		
	High Permittivity (Class2)	C6	X6S	−55 to +105°C		
		C7	X7S	−55 to +125°C		
		D7	X7T	−55 to +125°C		
2. Storage Condit	ions					
	Temperature Compensating(Class1)	-55 to +	-125℃			
			Specification	Temperature Range		
		B5	X5R	−55 to +85°C		
Specified Value	High Dayweittivity (Class?)	B7	X7R	−55 to +125°C		
	High Permittivity (Class2)	C6	X6S	−55 to +105°C		

3. Rated Voltage						
	Temperature Compensating	Standard	50VDC, 25VDC			
Specified Value	(Class1)	High Frequency Type	250VDC			
Specified value	High Permittivity (Class2)		630VDC, 250VDC, 100VDC 50VDC, 35VDC, 25VDC, 16VDC, 10VDC, 6.3VDC, 4VDC			

C7

X7S X7T -55 to +125°C

-55 to +125°C

4. Withstanding Voltage (Between terminals)						
Charified Value	Temperature Compensating(Class	s1)	No breakdown or damage			
Specified Value	High Permittivity (Class2)					
		Class 1		Class 2		
Test Methods and Remarks	Applied voltage	Rated voltage × 3 Rated voltage(Code Q) × 2		Rated voltage × 2.5 × 2 Rated voltage (Code Q) × 2, Rated voltage (Code S) × 1.		
and Remarks	Duration		1 to 5 sec.			
	Charge/discharge current	50mA max.				

5. Insulation Resis	5. Insulation Resistance					
	Temperature Compensating(Class1))	10000 MΩ min.			
Specified Value	High Permittivity (Class2) Note 1		C \leq 0.047 μ F : 10000 M Ω min. C $>$ 0.047 μ F : 500M Ω • μ F (C:Nominal capacitance)			
Test Methods and Remarks	Applied voltage : Rated voltage, 500Volume Duration : 60±5 sec. Charge/discharge current : 50mA max.		Code S)			

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6. Capacitance (Tolerance)							
Specified Value	Temperature Compensating (Class1)	Standard	$C \le 5pF$: $\pm 0.25pF$ $5pF < C \le 10pF$: $\pm 0.5pF$ $C > 10pF$: $\pm 5\%$ (C:Nominal capacitance)				
		High Frequency Type	requency Type Refer to detailed specification				
	High Permittivity (Class2)		±10% or ±20%				
			Class 1	Class 2			
		Standard	High Frequency Type	C≦10 μ F	C>10 μ F		
Test Methods	Preconditioning		None	Thermal treatment (at 150°C for 1hr) No.9			
and Remarks	Measuring frequency		/Hz±10%	1kHz±10%	120±10Hz		
	Measuring voltage Note 1	0.5	0.5 to 5Vrms		0.5±0.1rms		
	Bias application		None				

7. Q or Dissipation	n Factor					
Specified Value	Temperature Compensating (Class1)	Standard	Standard $C < 30pF : Q \ge 400 + 20C$ $C \ge 30pF : Q \ge 1000$ (C:Nominal capacitance)			
	(Glass1)	High Frequency Type	High Frequency Type Refer to detailed specification		tion	
	High Permittivity (Class2) Note 1		2.5% max.			
			Class 1	Class 2		
		Standard	High Frequency Type	C≦10 μ F	C>10 μ F	
Test Methods	Preconditioning		None	Thermal treatment (at 150°C for 1hr) No.9		
and Remarks	Measuring frequey	1 N	∕lHz±10%	1kHz±10%	120±10Hz	
	Measuring voltage Note 1	0.5	to 5Vrms	1±0.2Vrms	0.5±0.1Vrms	
	Bias application		N	lone		

8. Pre- and Post-Stress Electrical test

Measurement at 25±5°C

9. Heat treatment

Value shall be measured after test sample is heat treated at $150 + 0/-10^{\circ}C$ for an hour and kept at room temperature for 24 ± 2 hrs.

 $\frak{\%}$ Heat treatment is applicable to High dielectric type.

	Temperature Compensating (Class1)	Standard	Appearance Cap. Change Q	: No abnormality : Within $\pm 3\%$ or ± 0.3 pF, whichever is larger. : $C < 10$ pF : $Q \ge 200 + 10$ C $10 \le C < 30$ pF : $Q \ge 275 + 2.5$ C $C \ge 30$ pF : $Q \ge 350$ (C:Nominal capacitance) : 1000 M Ω min	
Specified Value		High Frequency Type	Appearance Cap. Change IR	: No abnormality : Within $\pm 3\%$ or ± 0.3 pF, whichever is larger. : $1000M\Omega$ min	
	High Permittivity (Class2) N	ote 1	Appearance Cap. Change $\tan\delta$ IR	: No abnormality : Within \pm 12.5% : 5% max : Within 500 or 100 whichever is smaller.	
Test Methods and Remarks	Heat treatment specified in this specification shall be conducted prior to test. No.9 Temperature: The maximum operating temperature shall be used. Duration: Unpowered 1000 hrs. Measurement shall be performed after test sample following the test is heated at 150+0/-10°C for an hour and kept at room temperat for 24±2 hrs. No.9				

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	Temperature Compensating	Standard	Appearance Cap. Change Q IR	: No abnormality : Within $\pm 2.5\%$ or $\pm 0.25 pF$, whichever is larger. : Initial value : Initial value
Specified Value	(Class1)	High Frequency Type	Appearance Cap. Change IR	: No abnormality : Within $\pm 2.5\%$ or ± 0.25 pF, whichever is larger. : Initial value
	High Permittivity (Class2)		Appearance Cap. Change tan δ IR	: No abnormality : Within ±7.5% : Initial value : Initial value
Test Methods and Remarks	Heat treatment specified in the Temperature: Minimum operate Number of cycles: 1000 cycles: Maximum dwell time at each the Maximum transition time: With Measurement shall be perform for 24±2 hours. No.9	ing temperature to Maxims s emperature extreme: 30 r in 1 min	num operating ten	

12. Destructive Pl	nysical Analysis
Specified Value	No abnormality
Test Methods and Remarks	Per EIA-469

13. Biased Humid	ity			
Specified Value	Temperature Compensating (Class1)	Standard	Appearance Cap. Change Q IR	: No abnormality : Within $\pm 7.5\%$ or ± 0.75 pF, whichever is larger. : C <30 pF : Q $\ge 100+10$ C/3 C ≥ 30 pF : Q ≥ 200 (C:Nominal capacitance) : 500 M Ω min
		High Frequency Type	Appearance Cap. Change	: No abnormality $: C \leqq 2.0 pF : \pm 0.4 pF \\ 2.0 pF < C < 10 pF : \pm 0.75 pF \\ C \leqq 10 pF : \pm 7.5\% (C : Nominal capacitance) \\ : 500M \Omega min$
	High Permittivity (Class2)	Note 1	Appearance Cap. Change tan δ IR	: No abnormality : Within \pm 12.5% : 5% max : Within 25 M $\Omega\mu$ F or 500 M Ω whichever is smaller.
Test Methods and Remarks	Heat treatment specified in the Temperature: 85°C Humidity: 85%RH Duration: 1000hrs Applied voltage: Rated voltage Measurement shall be perform for 24±2 hours. No.9	e and 1.3 to 1.5V.	·	b test. No.9 heated at 150 +0/ -10 °C for an hour and kept at room temperature

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14 Temperature (Cycle (Thermal Shock)						
The remperature	Syste (Thermal Glock)		Appearance Cap. Change	: No abnormality : Within $\pm 3.0\%$ or ± 0.3 pF, whichever is larger.			
	Temperature Compensating	Standard	Q	: C<10pF : Q≥200+10C 10≤ C<30pF : Q≥275+2.5C			
	(Class1)		IR	C ≥ 30pF : Q ≥ 350 (C:Nominal capacitance) : 1000M Ω min			
Specified Value		High Frequency Type	Appearance Cap. Change IR	: No abnormality : Within $\pm 3.0\%$ or $\pm 0.3 pF$, whichever is larger. : $1000M\Omega$ min			
	High Permittivity (Class2)	Note 1	Appearance Cap. Change tan δ IR	: No abnormality : Within \pm 12.5% : 5% max : Within 50M $\Omega\mu$ F or 1000M Ω , whichever is smaller.			
Test Methods and Remarks	Heat treatment specified in this specification shall be conducted prior to test. No.9 Temperature: Maximum operating temperature Duration: 1000hrs Applied voltage: Rated voltage Measurement shall be performed after test sample following the test is heated at 150+0/-10°C for an hour and kept at room temperation: 124±2 hours. No.9						
15. External Visua	I						
Specified Value	No abnormality						
Test Methods and Remarks	Visual inspection shall be performed.						
16. Physical Dime	naian						
Specified Value	I						
Test Methods	Refer to detailed specification						
and Remarks	Verify physical dimensions to	the applicable device spe	cification.				
17. Resistance to	Solvents						
Specified Value	Appearance : No abnorm Cap. Change : Initial value Q or $\tan\delta$: Initial value IR : Initial value $\tan\delta$	ue ue					
Test Methods and Remarks	Heat treatment specified in the Add Aqueous wash chemical (A 6% concentrated Oakite cle	OKEMCLEAN	onducted prior to	o test. No.9			
	(A 0% concentrated bakite cit	sarier) or equivalent.					
18. Mechanical Sh	lock						
Specified Value	Appearance : No abnorm Cap. Change : Initial valuing Q or $tan \delta$: Initial valuing R : Initial valuing R	ue ue					
Test Methods and Remarks	Heat treatment specified in this specification shall be conducted prior to test. No.9 Three shocks in each direction should be applied along 3 mutually perpendicular axes of the test specimen (18 shocks). Peak value: 1500g Duration: 0.5ms Test pulse: Half-sine Velocity change: 4.7m/s.						
19. Vibration							
Specified Value	Appearance : No abnore Cap. Change : Initial valu Q or tan δ : Initial valu IR : Initial valu	ue ue					
Test Methods and Remarks	Heat treatment specified in the 5g's for 20 min., 12 cycles ea Frequency range: 10Hz~2000	nis specification shall be c	· · · · · · · · · · · · · · · · · · ·	o test. No.9			

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Specified Value	Temperature Compensating (Class1)	Standard	Appearance Cap. Change Q IR	: No abnormality : Within ±2.5% or ±0.25pF, whichever is larger. : Initial value : Initial value	
	(OldSS1)	High Frequency Type	Appearance Cap. Change IR	: No abnormality : Within $\pm 2.5\%$ or ± 0.25 pF, whichever is larger. : Initial value	
	High Permittivity (Class2)	Note 1	Appearance Cap. Change tan δ IR	: No abnormality : Within ±7.5% : Initial value : Initial value	
Test Methods and Remarks	Heat treatment specified in this specification shall be conducted prior to test. No.9 Dipping Solder: 260±5°C Time: 10±1 sec. Measurement shall be performed after test sample following the test kept at room temperature for 24±2hours.				

Specified Value	Appearance: No abnormality R: Initial value
	Heat treatment specified in this specification shall be conducted prior to test. No.9 Per AEC-Q200-002

22. Solderability	
Specified Value	More than 95% of terminal electrode shall be covered with fresh solder.
Test Methods and Remarks	(a) Pb Free Solder Solder at 235±5°C for 5sec. (b) SnPb Solder Solder at 215±5°C for 5sec. (c) Wave Soldering (Pb Free Solder) Solder at 260±5°C for 7sec.

23. Temperature 0	23. Temperature Characteristic									
		Temp. chara. [ppm/°C]			Tolerance[ppm/°C]					
					G: ±30					
	Temperature Compensating (Class1)	C□:0	CG	, CH, CJ, CK	H: ±60					
Specified Value					J: ±120					
					K: ±250					
	High Permittivity(Class2)			Capacitance	e Reference	Temperature				
				change rate	temperature	range				
		B5	X5R	±15%	25°C	-55 ~ +85°C				
		B7	X7R	±15%	25°C	$-55\sim+125^{\circ}C$				
		C6	X6S	±22%	25°C	-55~+105°C				
		C7	X7S	±22%	25°C	-55~+125°C				
		D7	X7T	+22/-33%	6 25°C	-55 ~ +125°C				
Test Methods	Heat treatment specified in this specification	n shall be	conducted	prior to test. N	o.9					
and Remarks	Capacitance shall be measured at room ten	nperature a	is well as n	ninimum and maxi	mum operating temperat	cures.				

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24. Board Flex

Specified Value

Appearance: No abnormality Cap. Change: ±12.5%

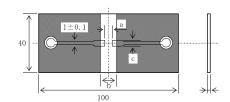
Heat treatment specified in this specification shall be conducted prior to test. No.9

Test sample is soldered onto the test board shown in Fig 1.

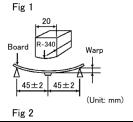
The board is bent 2.0mm for 60 seconds as shown in Fig 2.

Measurement shall be conducted as the board is bent 2.0mm.

Test Methods and Remarks



		Case size[mm]						
Dimension	0603	1005	1608	2012	3216	3225	4532	
а	0.3	0.4	1.0	1.2	2.2	2.2	3.5	
b	0.9	1.5	3.0	4.0	5.0	5.0	7.0	
С	0.3	0.5	1.2	1.65	2.0	2.9	3.7	
Thickness	0.8	1.6						



25. Terminal Strength

Specified Value | Appearance: No abnormality

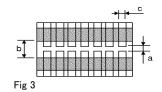
Per AEC-Q200-006

Test sample is soldered onto the test board shown in Fig 3.

0603 or greater (case size): 17.7N for 60 ± 5 sec

0402 (case size): 5N for 30 ± 5 sec. 0201 (case size): 2N for 30 ± 5 sec.

Test Methods and Remarks



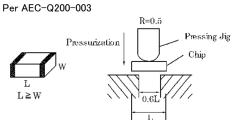
		Case size[mm]							
Dimension	0603	1005	1608	2012	3216	3225	4532		
а	0.3	0.4	1.0	1.2	2.2	2.2	3.5		
b	0.9	1.5	3.0	4.0	5.0	5.0	7.0		
С	0.3	0.5	1.2	1.65	2.0	2.9	3.7		

26. Beam Load Test

Specified Value

Destruction value should exceed 5N.

Test Methods and Remarks



Note 1 The figures indicate typical specifications. Please refer to individual specifications in detail.

PRECAUTIONS

1. Circuit Design

- ◆Verification of operating environment, electrical rating and performance
 - 1. A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications

Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

Precautions

- ◆Operating Voltage (Verification of Rated voltage)
 - 1. The operating voltage for capacitors must always be their rated voltage or less.
 - If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less.
 - For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.

 2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency
 - 2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either AC voltage or a pulse voltage having rapid rise time is used in a circuit.

2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance. Therefore, the following items must be carefully considered in the design of land patterns:
 - (1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.
 - (2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.
- ◆Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

◆Pattern configurations (Design of Land-patterns)

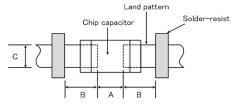
The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.

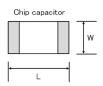
- (1) Recommended land dimensions for typical chip capacitors
- Multilayer Ceramic Capacitors : Recommended land dimensions (unit: mm)

Wave-soldering

Type		1608	2012	3216	3225	
C: L		1.6	2.0	3.2	3.2	
Size	W	0.8	1.25	1.6	2.5	
Α		0.8 to 1.0	1.0 to 1.4	1.8 to 2.5	1.8 to 2.5	
В		0.5 to 0.8	0.8 to 1.5	0.8 to 1.7	0.8 to 1.7	
С		0.6 to 0.8	0.9 to 1.2		1.8 to 2.5	

Land patterns for PCBs





Technical considerations

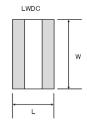
Reflow-soldering

	TOTAL STATE IN STATE									
	Туре	0201	0402	0603	1005	1608	2012	3216	3225	4532
Siz	L	0.25	0.4	0.6	1.0	1.6	2.0	3.2	3.2	4.5
312	W	0.125	0.2	0.3	0.5	0.8	1.25	1.6	2.5	3.2
	Α	0.095~0.135	0.15~0.25	0.20~0.30	0.45~0.55	0.6~0.8	0.8~1.2	1.8~2.5	1.8~2.5	2.5~3.5
	В	0.085~0.125	0.10~0.20	0.20~0.30	0.40~0.50	0.6~0.8	0.8~1.2	1.0~1.5	1.0~1.5	1.5~1.8
	С	0.110~0.150	0.15~0.30	0.25~0.40	0.45~0.55	0.6~0.8	0.9~1.6	1.2~2.0	1.8~3.2	2.3~3.5

Note: Recommended land size might be different according to the allowance of the size of the product.

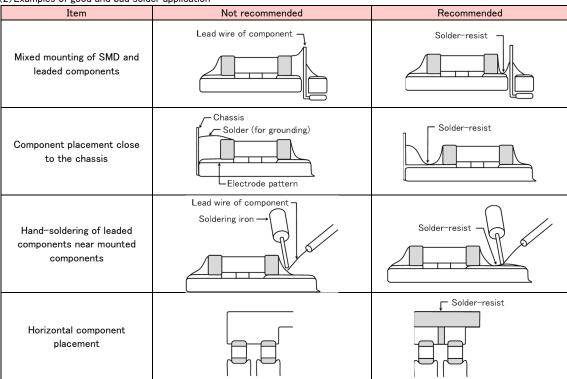
● LWDC: Recommended land dimensions for reflow-soldering (unit: mm)

Туре		0510	0816	1220	
Size	L	0.52	0.8	1.25	
	W	1.0	1.6	2.0	
Α		0.18~0.22	0.25~0.3	0.5~0.7	
В		0.2~0.25	0.3~0.4	0.4~0.5	
С		0.9~1.1	1.5~1.7	1.9~2.1	

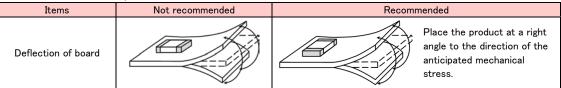


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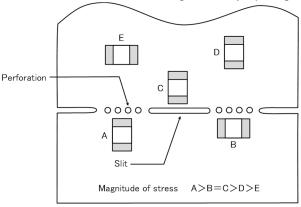
(2) Examples of good and bad solder application



- ◆Pattern configurations (Capacitor layout on PCBs)
 - 1-1. The following is examples of good and bad capacitor layouts; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.



1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

3. Mounting

- ◆Adjustment of mounting machine
 - 1. When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
 - 2. Maintenance and inspection of mounting machines shall be conducted periodically.

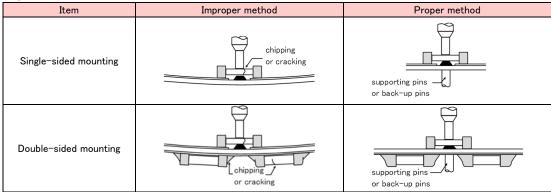
Precautions

- ◆Selection of Adhesives
 - 1. When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked: size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.

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◆Adjustment of mounting machine

- 1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
 - (1) The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
 - (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:



Technical considerations

2. As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors.

To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted periodically.

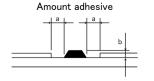
◆Selection of Adhesives

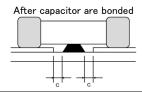
Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
 - a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive shall have sufficient strength at high temperatures.
 - c. The adhesive shall have good coating and thickness consistency.
 - d. The adhesive shall be used during its prescribed shelf life.
 - e. The adhesive shall harden rapidly.
 - f. The adhesive shall have corrosion resistance.
 - g. The adhesive shall have excellent insulation characteristics.
 - h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- (2) The recommended amount of adhesives is as follows;

[Recommended condition]

Figure	2012/3216 case sizes as examples
а	0.3mm min
b	100 to 120 μ m
С	Adhesives shall not contact land





4. Soldering

Precautions

Technical

considerations

◆Selection of Flu

Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;

- (1) Flux used shall be less than or equal to 0.1 wt%(in CI equivalent) of halogenated content. Flux having a strong acidity content shall not be applied.
- (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
- (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

◆Soldering

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions.

Sn-Zn solder paste can adversely affect MLCC reliability.

Please contact us prior to usage of Sn-Zn solder.

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to corrosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.

- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods

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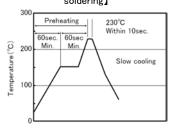
and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

♦Soldering

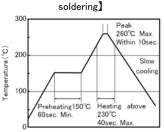
- · Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- · Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal
- Preheating: Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 130°C.
- · Cooling: The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.

[Reflow soldering]

【Recommended conditions for eutectic soldering】

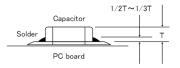


[Recommended condition for Pb-free



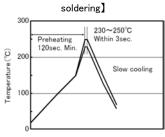
Caution

- ①The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- ②Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible, soldering for 2 times.

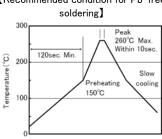


[Wave soldering]

[Recommended conditions for eutectic



[Recommended condition for Pb-free

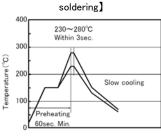


Caution

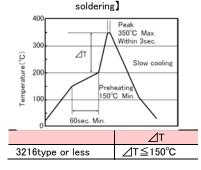
①Wave soldering must not be applied to capacitors designated as for reflow soldering only. soldering for 1 times.

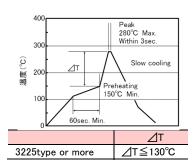
[Hand soldering]

[Recommended conditions for eutectic



[Recommended condition for Pb-free





Caution

- ①Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- ②The soldering iron shall not directly touch capacitors. soldering for 1 times.

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5. Cleaning ◆Cleaning conditions 1. When PCBs are cleaned after capacitors mounting, please select the appropriate cleaning solution in accordance with the intended use Precautions of the cleaning. (e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics. 1. The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance). 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the cracking of Technical considerations capacitors or the soldered portion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall be carefully Ultrasonic output: 20 W/l or les Ultrasonic frequency: 40 kHz or less Ultrasonic washing period: 5 min. or less

6. Resin coating and mold 1. With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the capacitor's performance. 2. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat Precautions may lead to damage or destruction of capacitors. The use of such resins, molding materials etc. is not recommended.

7. Handling	
Precautions	 ◆Splitting of PCB 1. When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board. 2. Board separation shall not be done manually, but by using the appropriate devices. ◆Mechanical considerations Be careful not to subject capacitors to excessive mechanical shocks. (1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used. (2) Please be careful that the mounted components do not come in contact with or bump against other boards or components.

Precautions	♦Storage
	To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to contro temperature and humidity in the storage area. Humidity should especially be kept as low as possible. Recommended conditions
	Ambient temperature : Below 30°C Humidity : Below 70% RH
	The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery.
	•Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air.
	2. The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, so care shall be taken to design circuits. Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1hour.
Technical considerations	If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/packaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the capacitors.

Please check the guide regarding precautions for deflection test, soldering by spot heat, and so on.

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